

Plasmonic Noise of Field-Effect Transistors Operating at Terahertz Frequencies

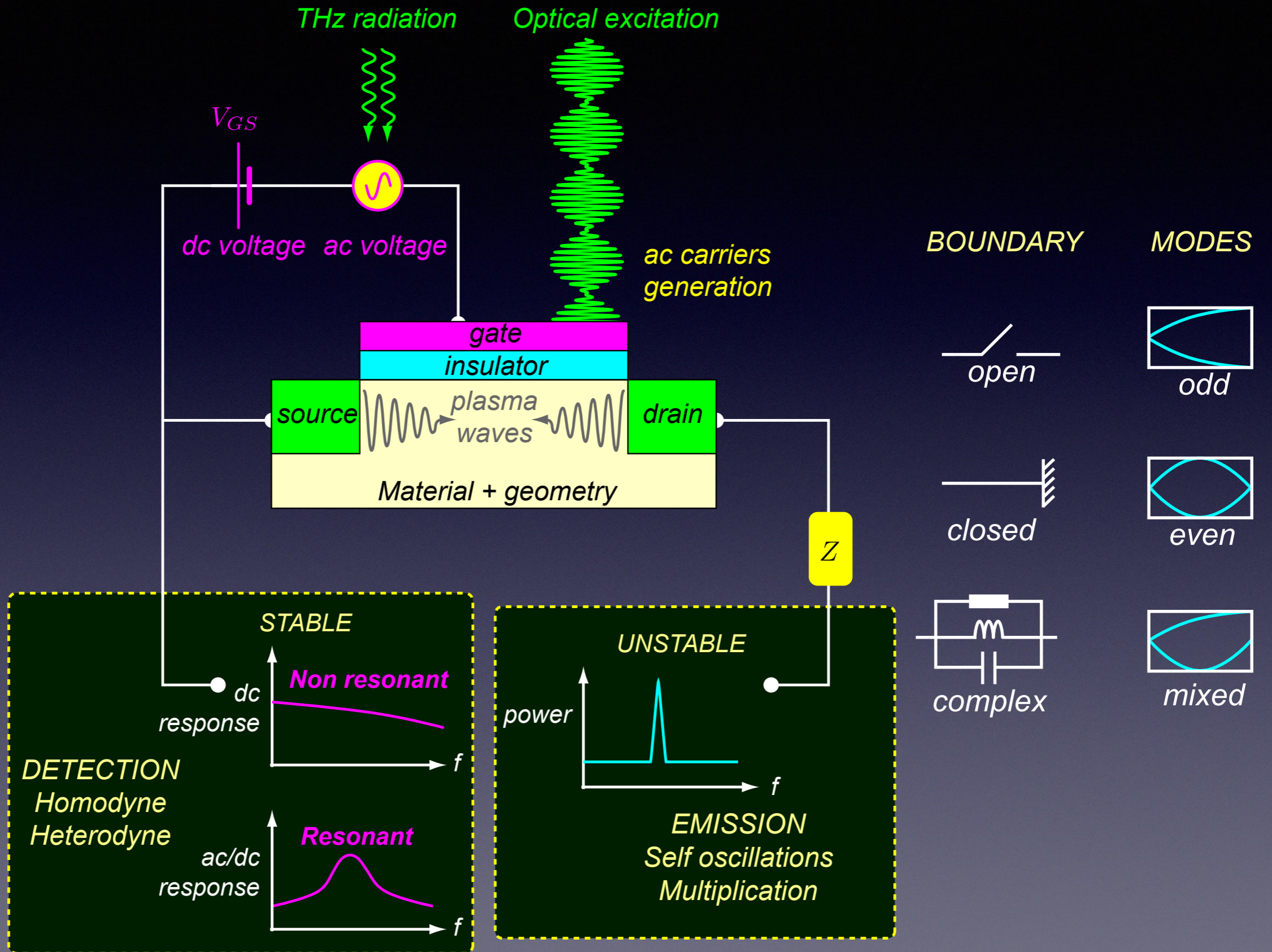
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Physical Scenario

INPUT



1st ingredient: Transport

Continuity $\frac{\partial n}{\partial t} + \frac{\partial nv}{\partial x} = 0$

Hydrodynamic $\frac{\partial v}{\partial t} + \frac{\partial}{\partial x} \left[\frac{v^2}{2} + \frac{e}{m^*} \varphi \right] + e\nu D \frac{\partial n}{\partial x} + v\nu = \tilde{f}$

Material parameters

Effective mass

$$m^*$$

Relaxation rate

$$\nu$$

Diffusion

$$D$$

Langevin force

$$\tilde{f}$$

2nd ingredient: Potential

Pseudo 2D
Poisson

$$\underbrace{\varepsilon_c \frac{\partial^2 \varphi}{\partial x^2}}_{\text{longitudinal}} + \underbrace{\varepsilon_s \frac{U_g - \varphi}{d(x)\delta}}_{\text{transverse}} = \frac{e}{\varepsilon_0} [n(x) - N_D(x)]$$

longitudinal transverse

Geometrical parameters

| | | | |
|-------------------|---------------|------------------------------|-------------------------|
| Channel thickness | Gate distance | 3D | 2D |
| δ | $d(x)$ | $d\delta \rightarrow \infty$ | $d\delta \rightarrow 0$ |

3rd ingredient: Boundaries

Voltage driven

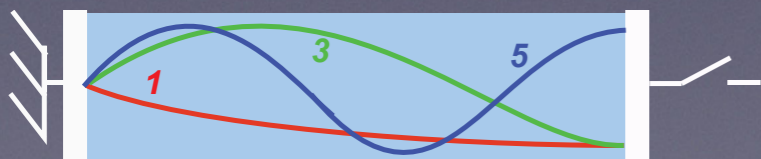
$$\begin{cases} \varphi(0) = 0 \\ \varphi(L) = V_D \end{cases}$$

Current driven

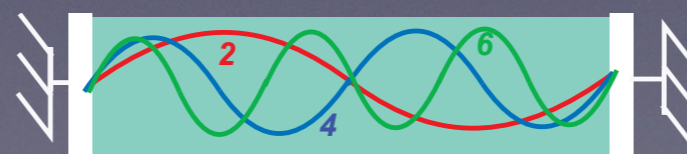
$$\begin{cases} \varphi(0) = 0 \\ \frac{\partial E(L,t)}{\partial t} = \frac{1}{\epsilon_c \epsilon_0} [j_{tot} - en(L,t)v(L,t)] \end{cases}$$

External circuit

Open circuit



Closed Circuit



Complex charge

$$\bar{Z} = R + jX$$

4th ingredient: Noise

$$S_{\xi\xi}(\omega) = \int_0^L n(x_0) |G_{\xi}(\omega, x_0)|^2 S_{ff}(x_0) dx_0$$

$$\xi = \begin{cases} U & \text{Voltage} \\ J & \text{Current} \end{cases}$$

Spectral
response
function

$\frac{4k_B T \nu}{m^*}$ Noise
source

Transfer Impedance Field

Voltage and Current

$$S_{UU}, S_{JJ}$$

Local contribution

$$\delta S_{\xi\xi}$$

Admittance, Impedance

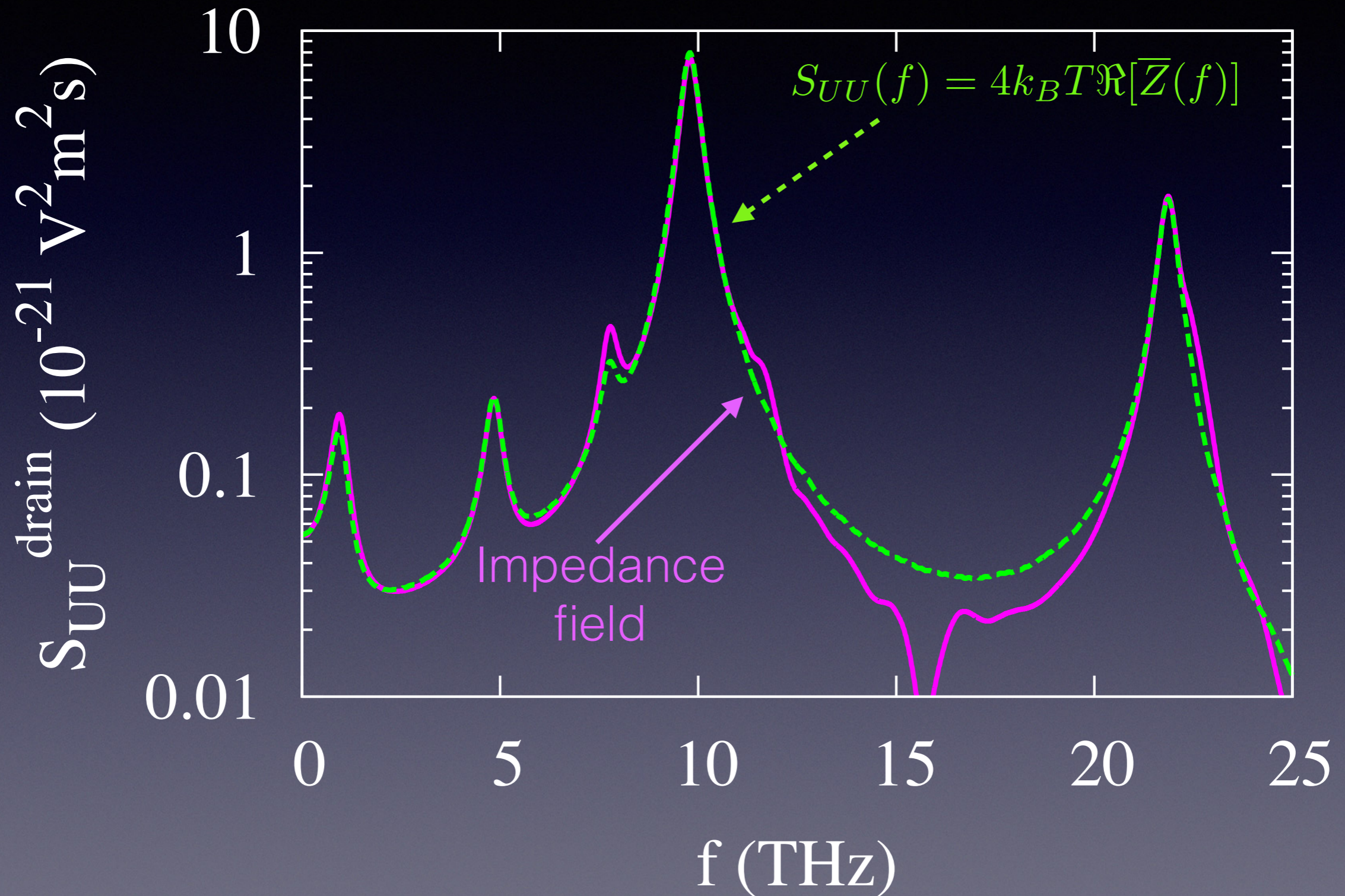
$$\bar{Y}, \bar{Z}$$

Overview of

- *open problems,*
- *critical points,*
- *difficulties,*
- *etc...*

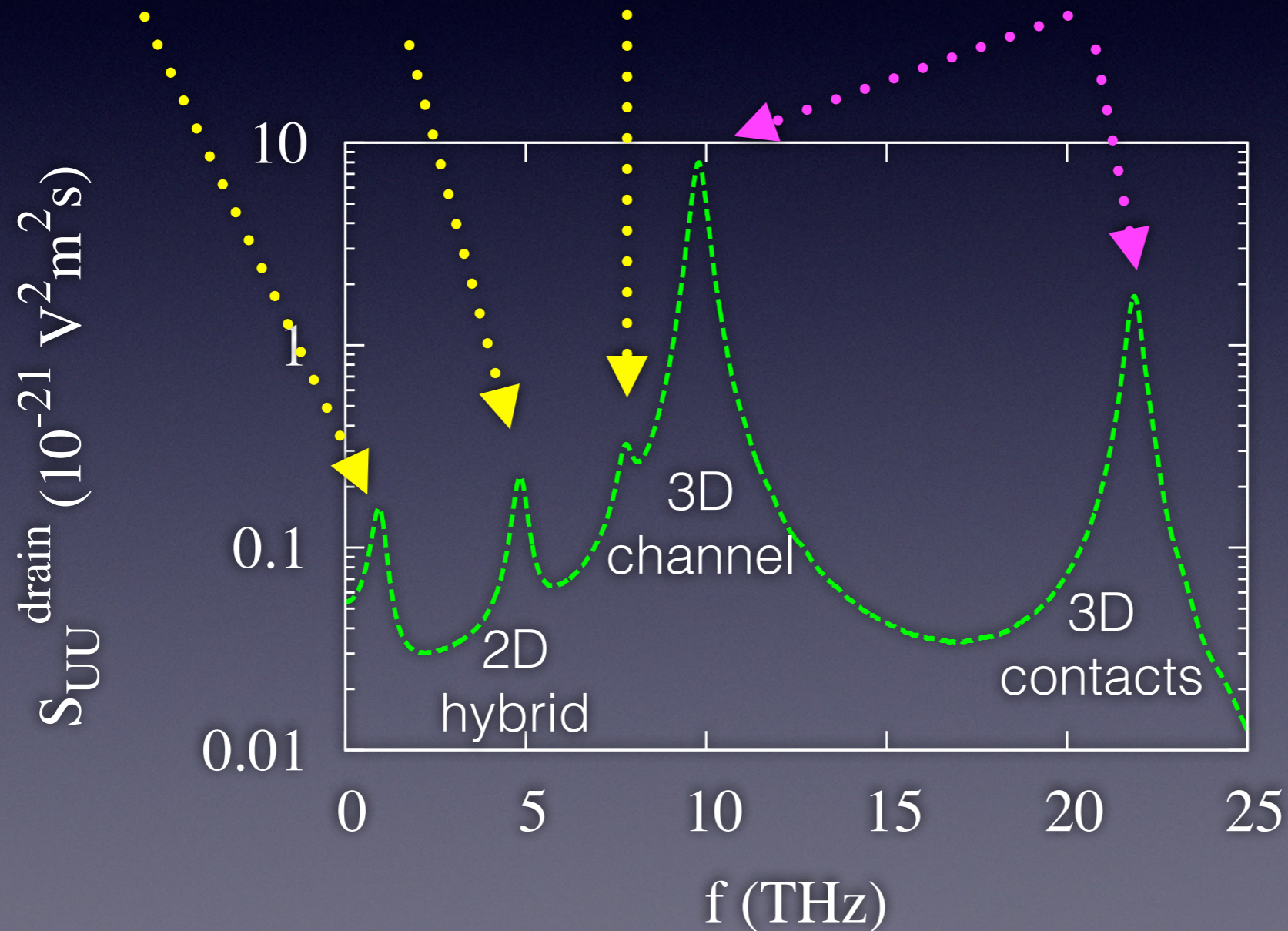
PROBLEM 1: NOISE CALCULATION

Can we apply Nyquist relation to transistors?



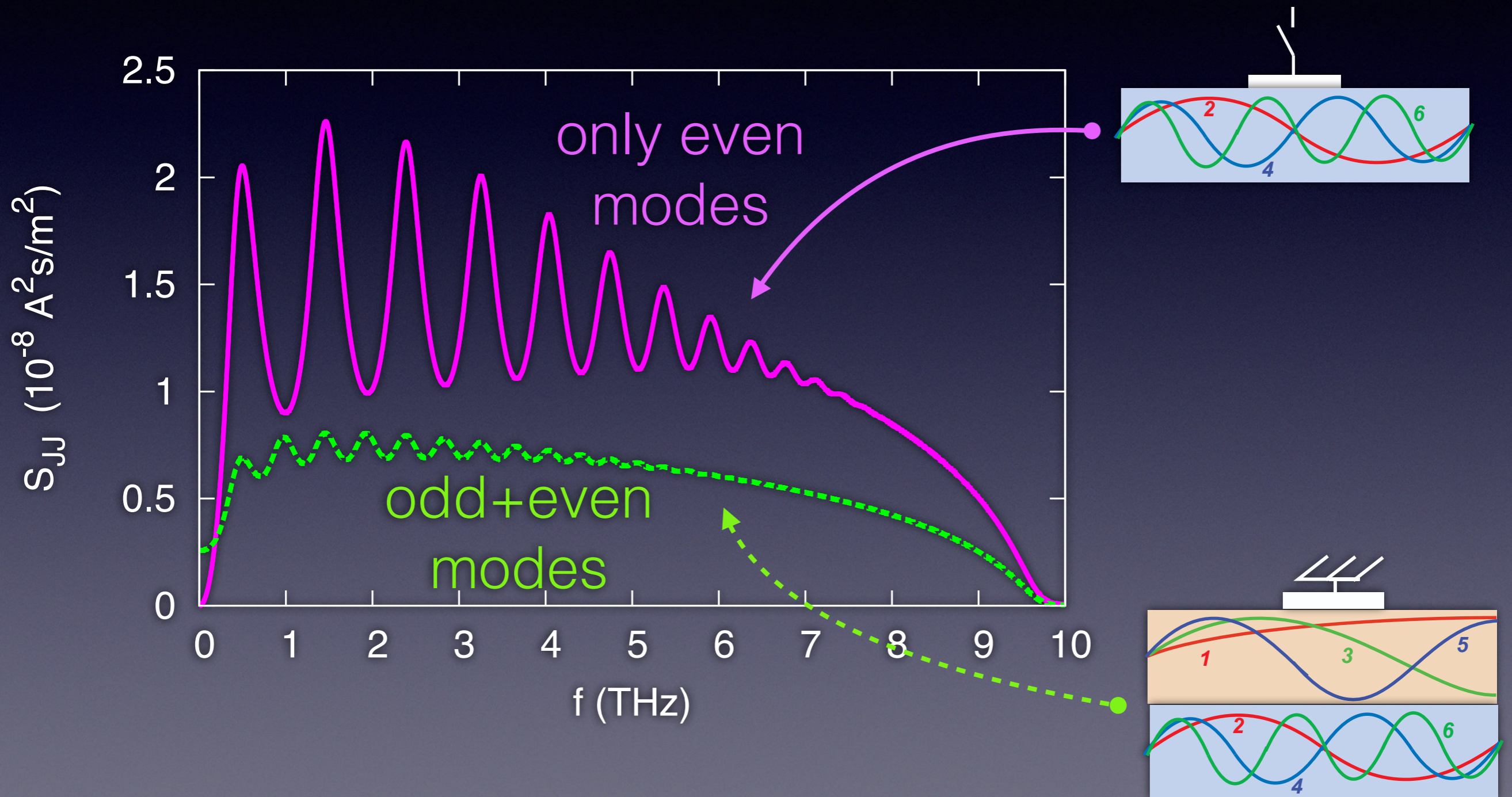
PROBLEM 2: DIMENSIONALITY

What is the role of the channel thickness δ ?



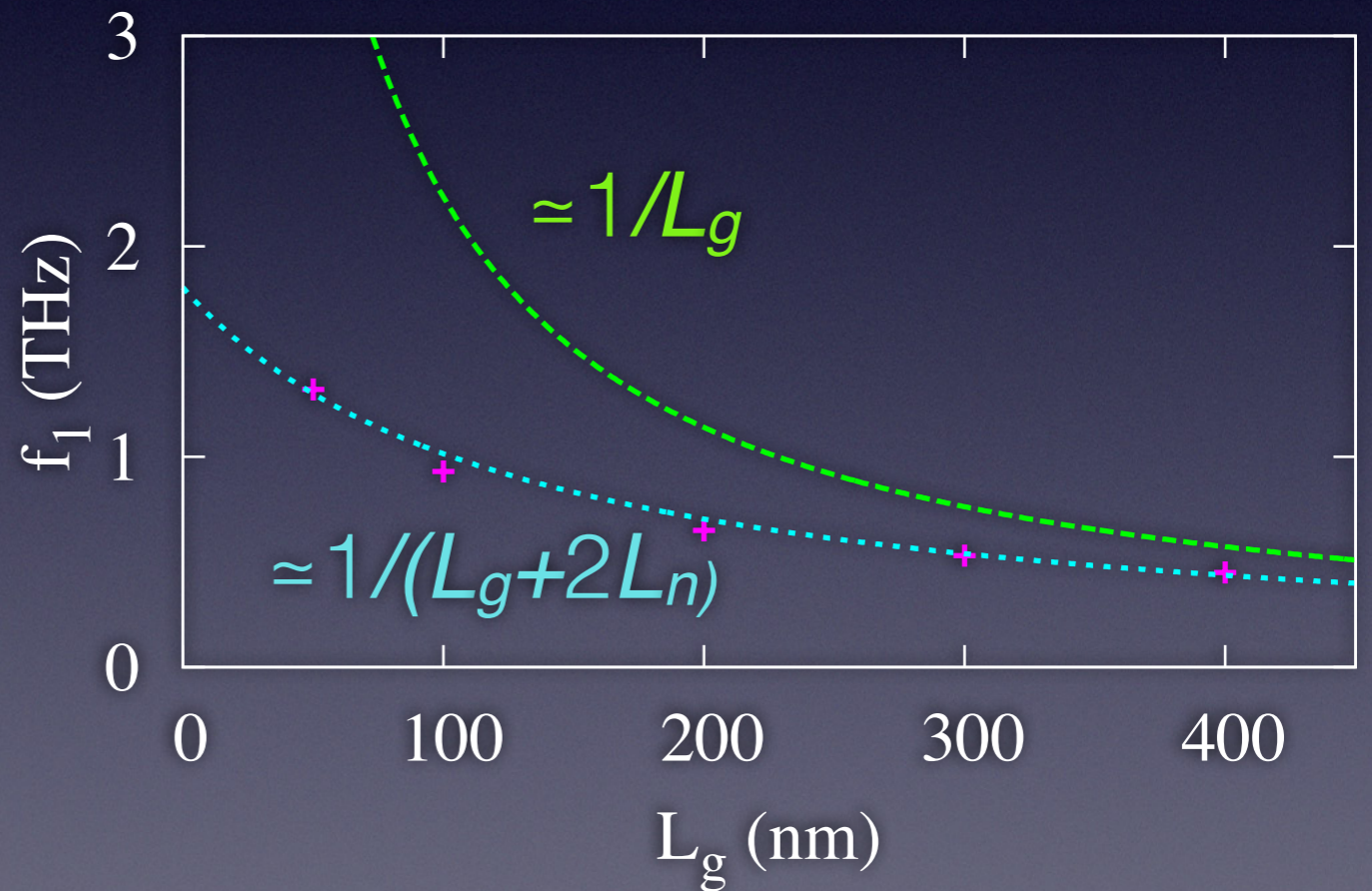
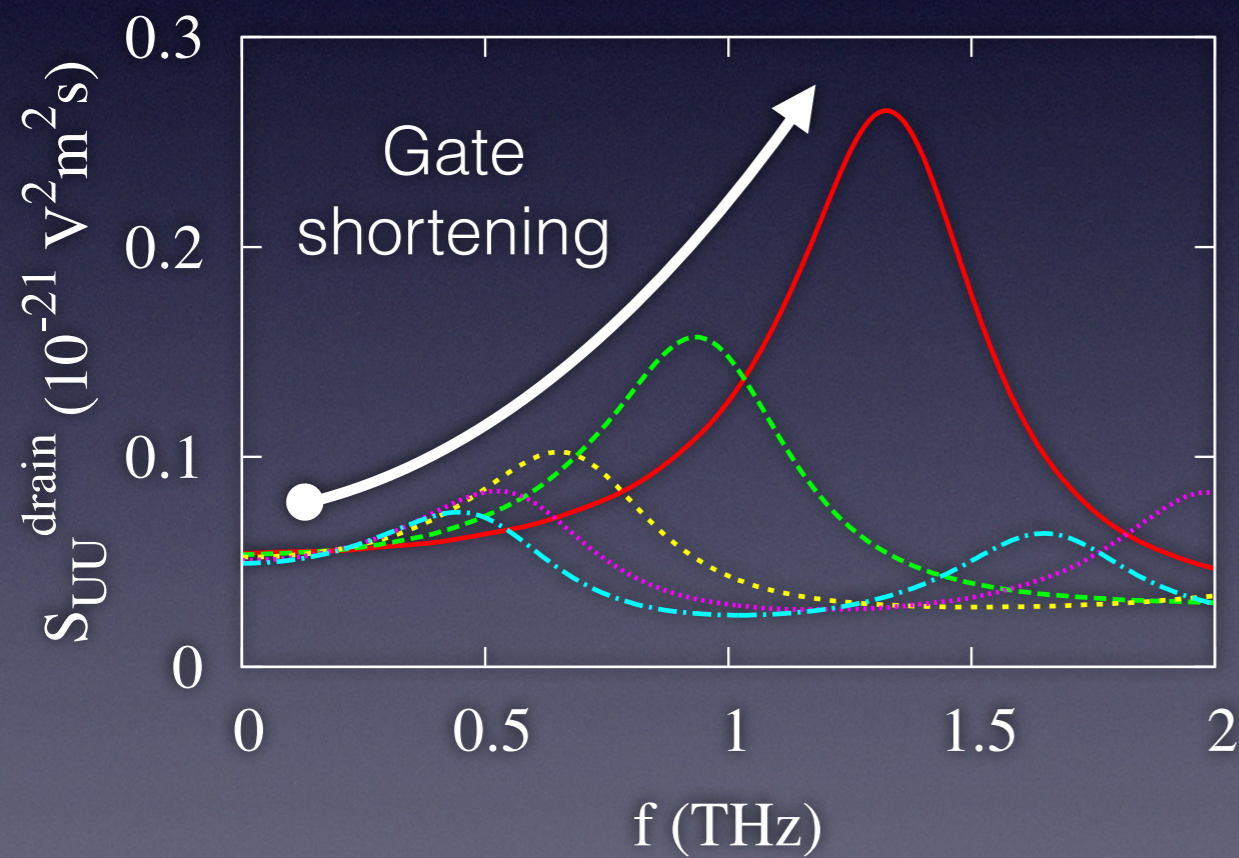
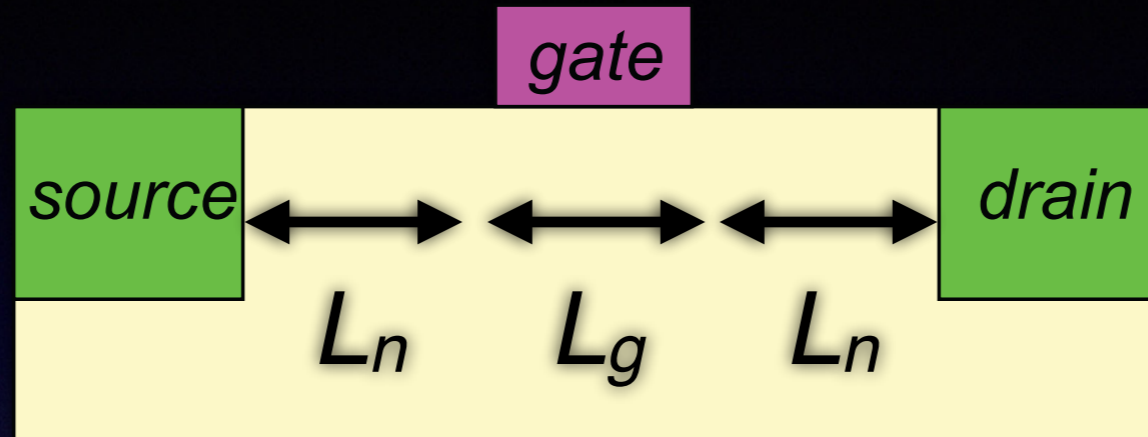
PROBLEM 3: ENVIRONMENT

Can we tune noise by the embedding circuit?



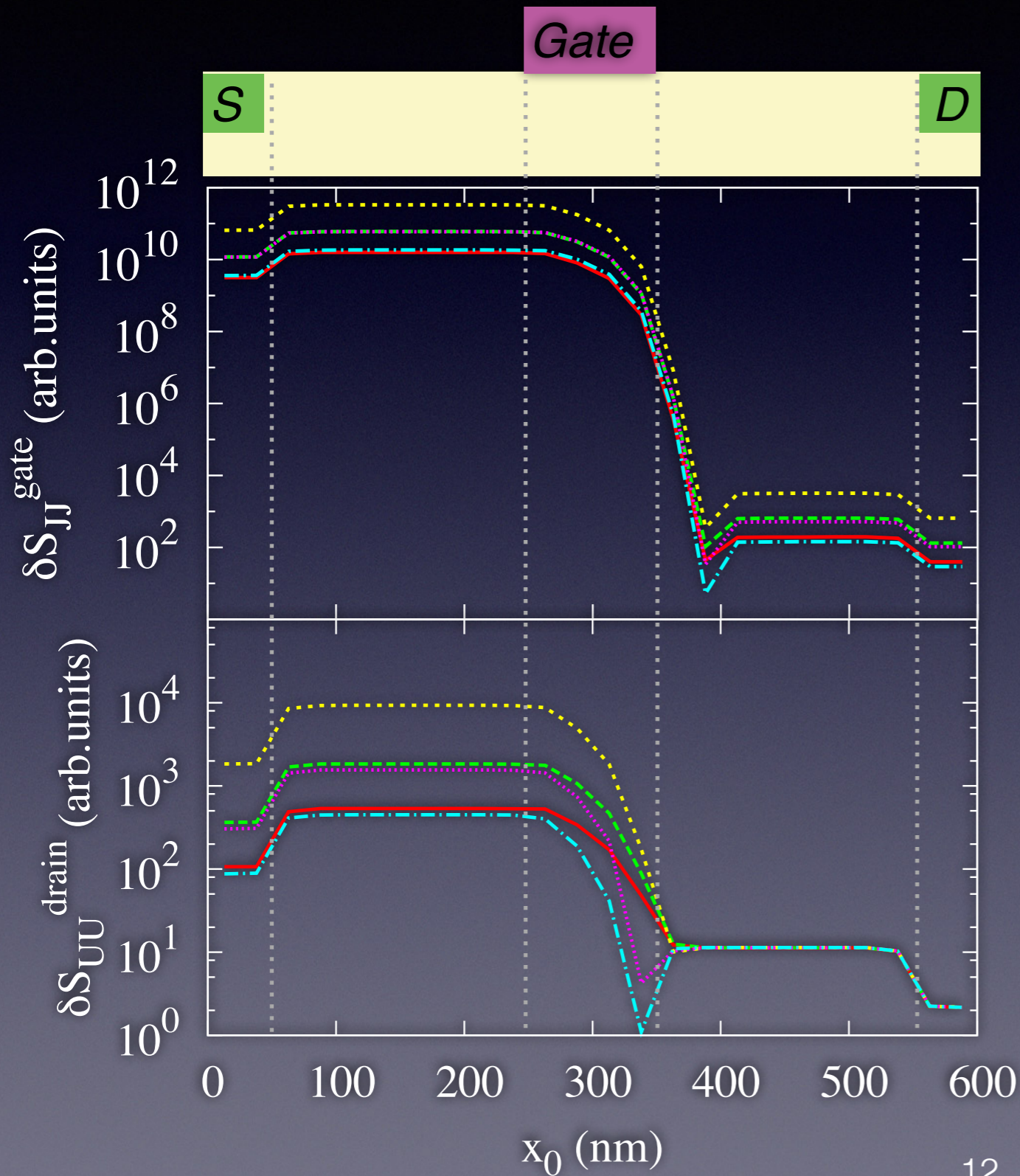
PROBLEM 4: DEVICE TOPOLOGY

What is the effect of gate/channel lengths?



PROBLEM 5: NOISE DISTRIBUTION

Where the noise comes from?



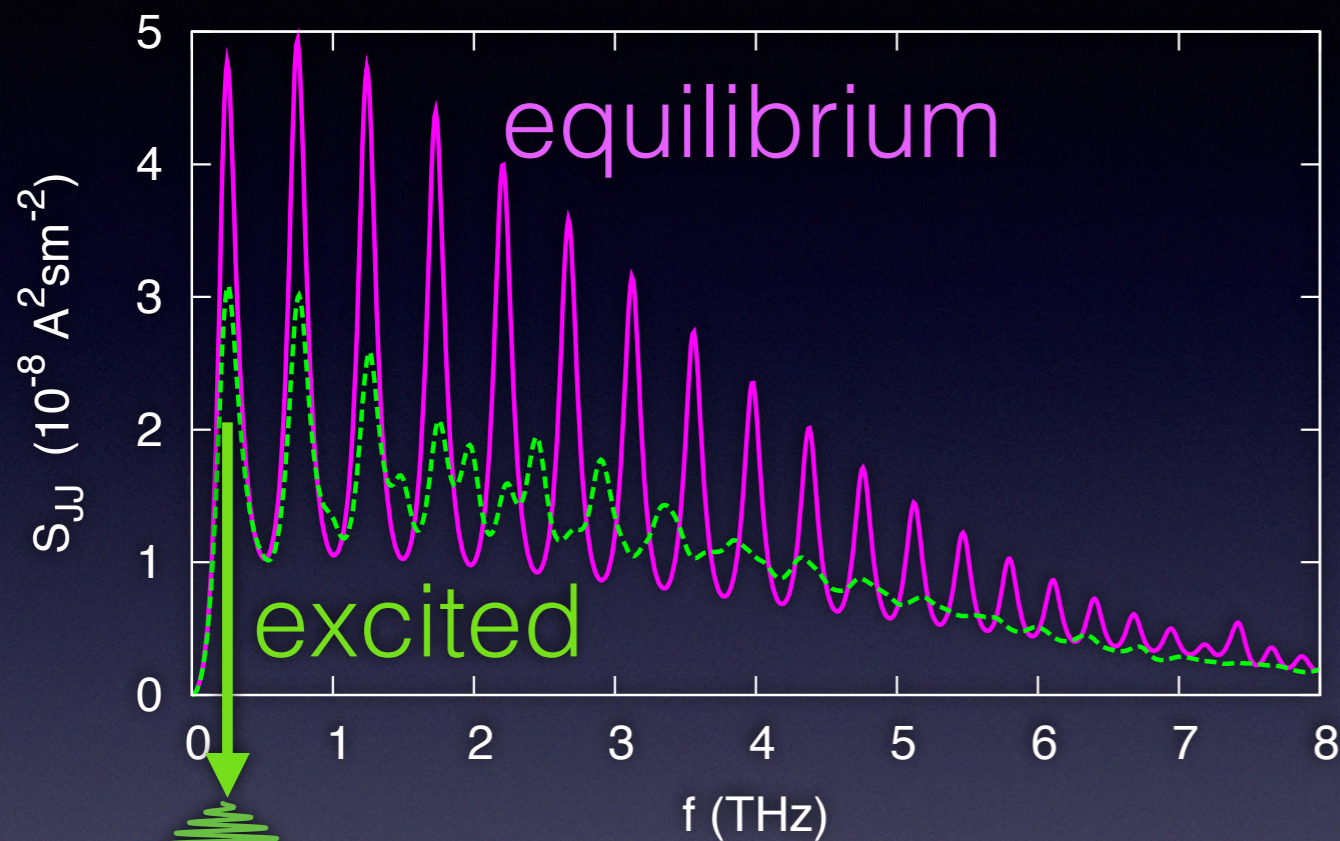
Local contribution

$$\delta S_{\xi\xi} = n(x_0) |G_{\xi}(\omega, x_0)|^2 S_{ff}(x_0)$$

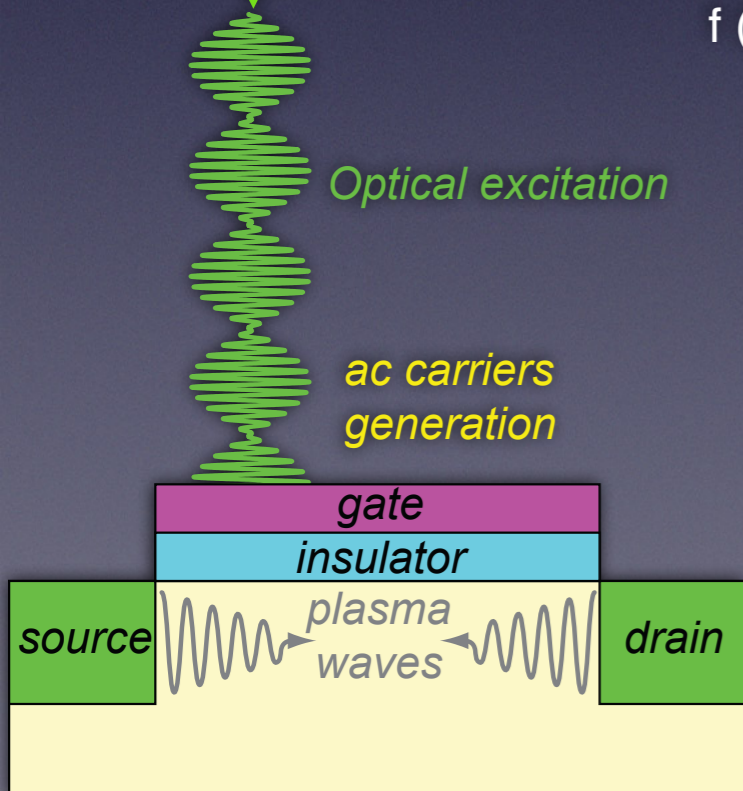
$$S_{\xi\xi}(\omega) = \int_0^L \delta S_{\xi\xi} dx_0$$

PROBLEM 6: NOISE SUPPRESSION

What is the effect of an external excitation?

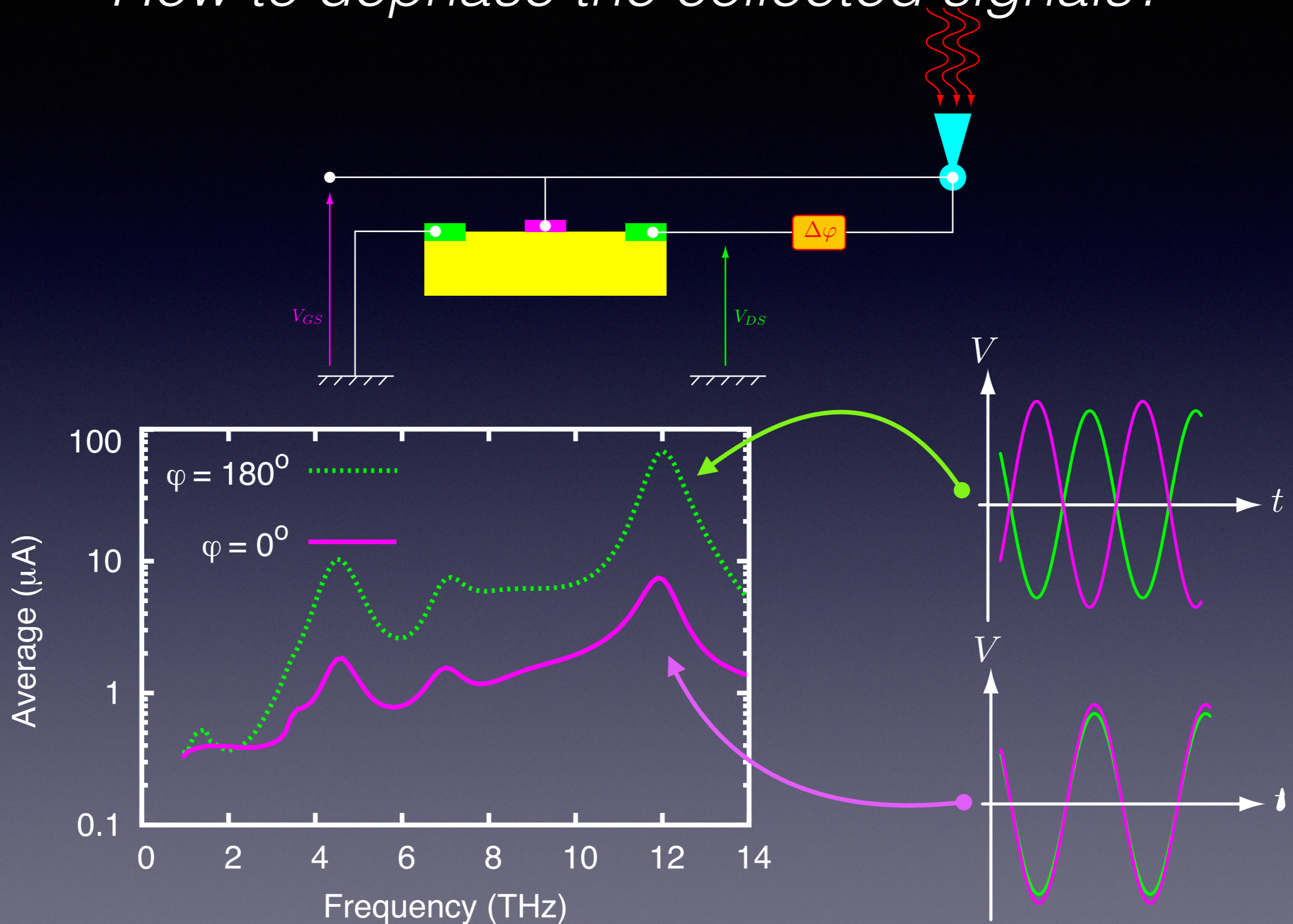


Thermally excited
vs
optically excited
plasmonic noise



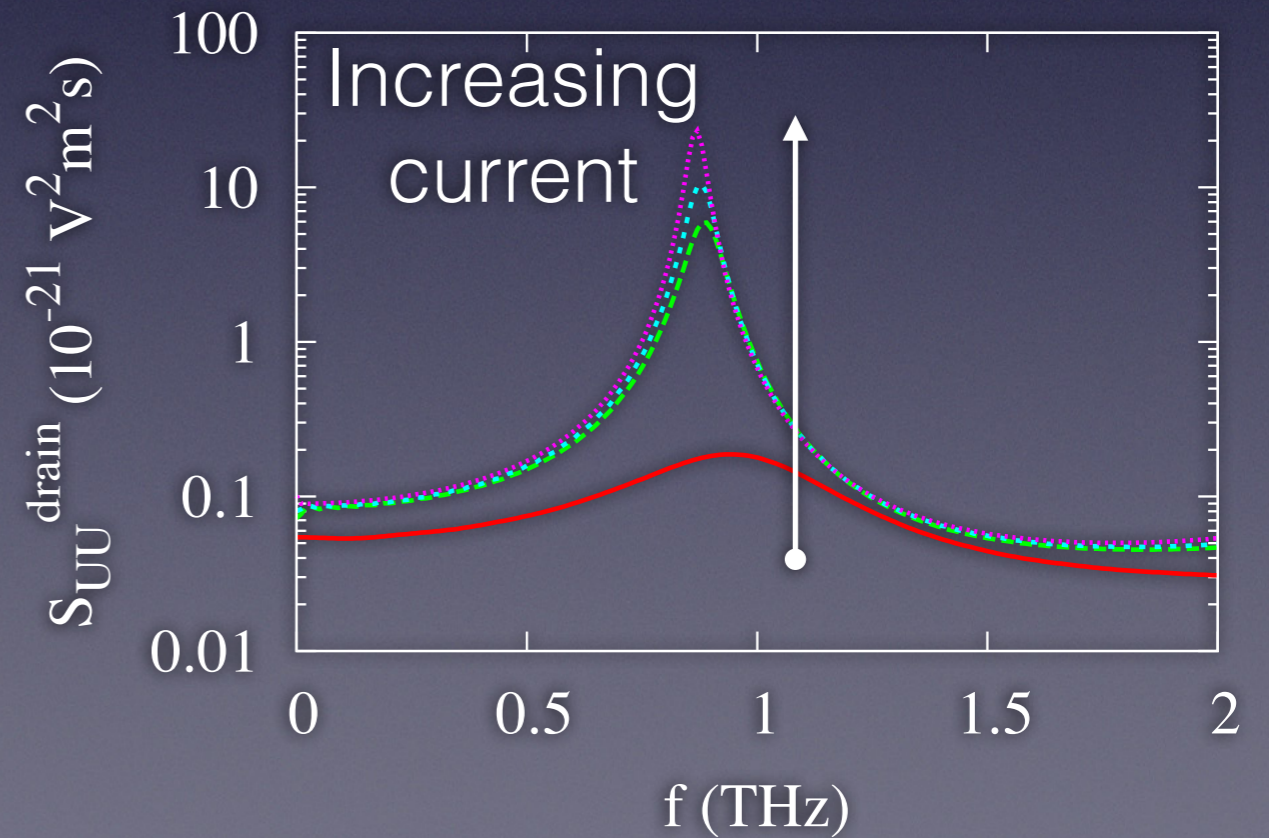
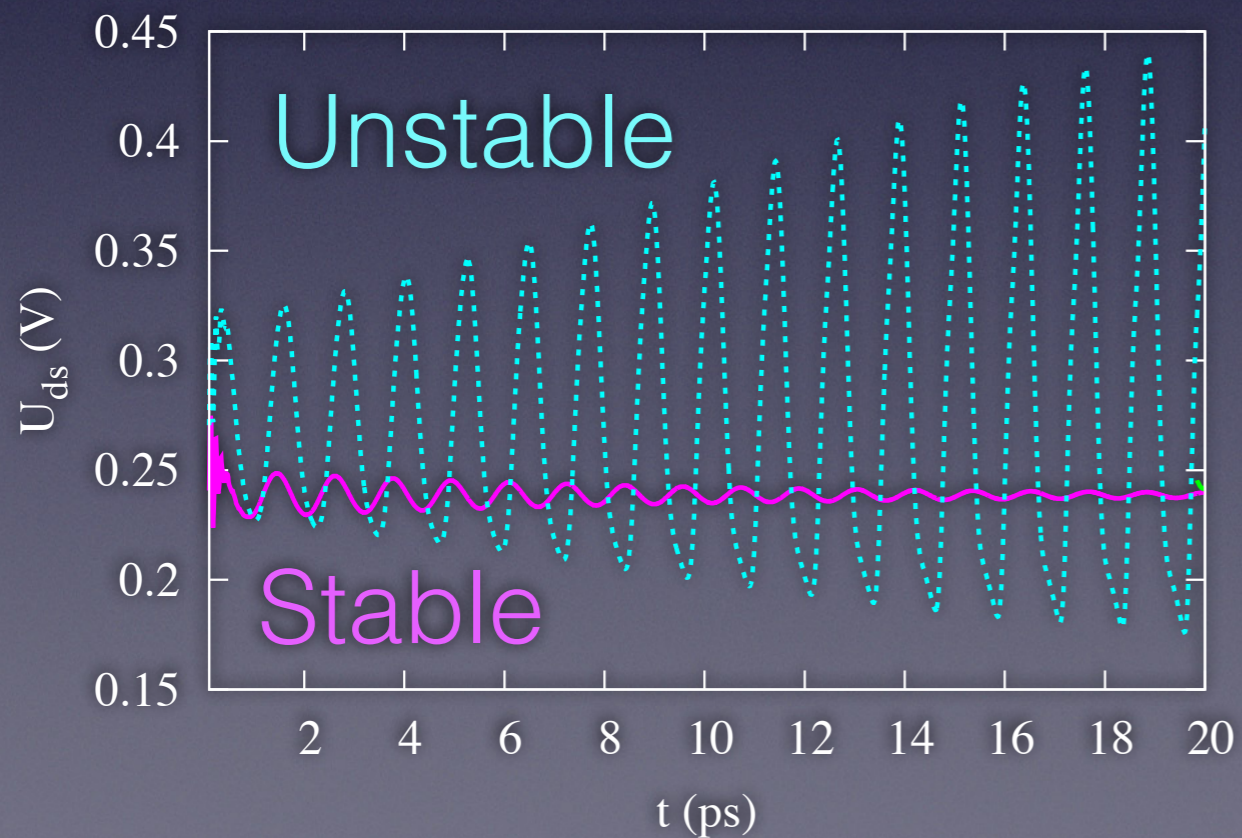
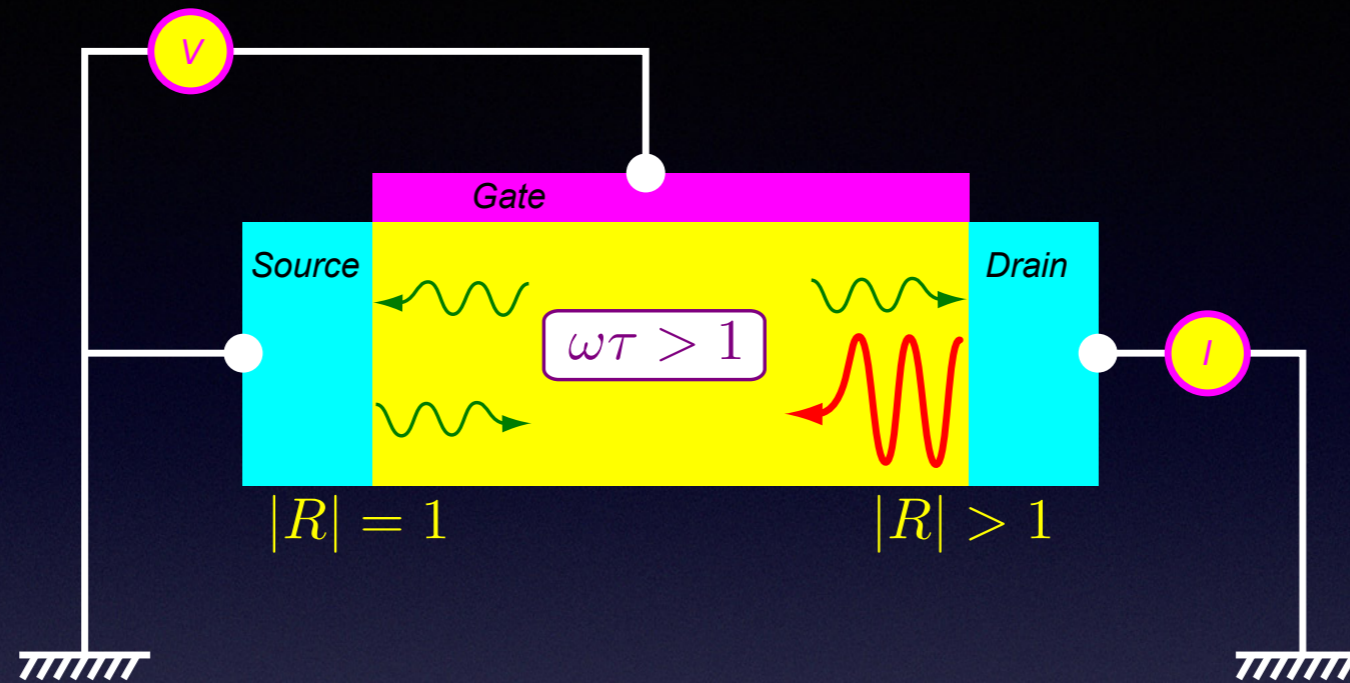
PROBLEM 7: IMPROVE SIGNAL-TO-NOISE

How to dephase the collected signals?



PROBLEM 8: PLASMA INSTABILITY

How to reach self-oscillations conditions?





Thank you for your
~~attention~~
answers